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November 1999

### **FDS6890A** Dual N-Channel 2.5V Specified PowerTrench<sup>™</sup> MOSFET

#### **General Description**

These N-Channel 2.5V specified MOSFETs are produced using Fairchild Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance and yet maintain low gate charge for superior switching performance.

#### **Applications**

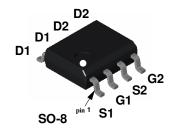
- DC/DC converter
- Motor drives

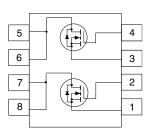
#### Features

• 7.5 A, 20 V.  $\rm R_{\rm DS(ON)}$  = 0.018  $\Omega~$  @  $\rm V_{\rm GS}$  = 4.5 V

 $R_{DS(ON)} = 0.022 \ \Omega \ @ V_{GS} = 2.5 \ V.$ 

- Low gate charge (23nC typical).
- Fast switching speed.
- High performance trench technology for extremely low R<sub>DS(ON)</sub>.
- High power and current handling capability.





#### Absolute Maximum Ratings T<sub>A=25°C unless otherwise noted</sub>

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-Source Voltage		20	V
V <sub>GSS</sub>	Gate-Source Voltage		±8	V
I <sub>D</sub> E	Drain Current - Continuous	(Note 1a)	7.5	A
	- Pulsed		20	
P <sub>D</sub> Power Dissipation for Dual Operation			2.0	W
	Power Dissipation for Single Operation	(Note 1a)	1.6	
		(Note 1b)	1.0	
		(Note 1c)	0.9	
T <sub>J</sub> , T <sub>stg</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

#### Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
$R_{_{\theta}JC}$	Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W
			90	

#### Package Marking and Ordering Information

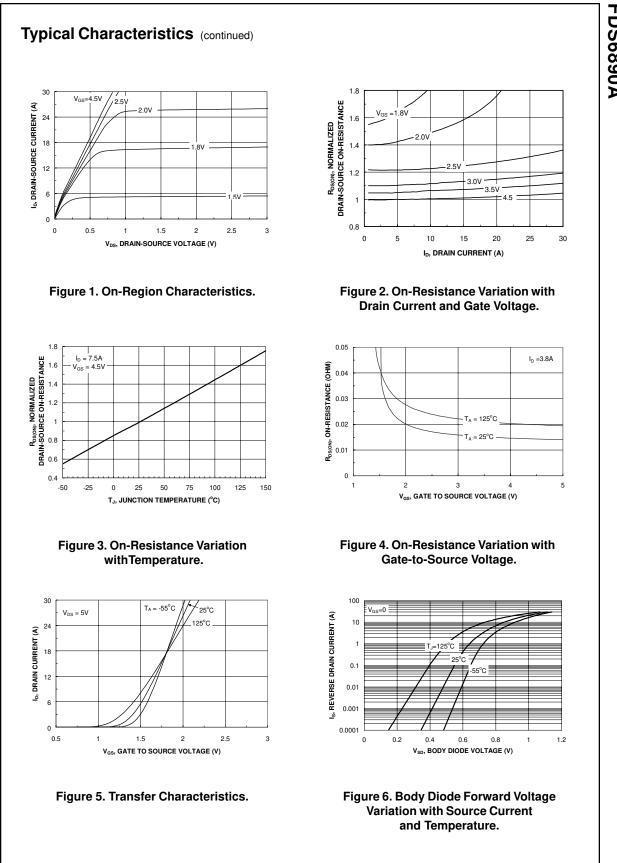
Device Marking	Device	Reel Size	Tape Width	Quantity
FDS6890A	FDS6890A	13	12mm	2500 units

eristics ain-Source Breakdown Voltage		I	Тур	Max	Units
			<u>.                                    </u>		
	$V_{GS} = 0 V, I_D = 250 \mu A$	20			V
eakdown Voltage Temperature efficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		14		mV/°C
ro Gate Voltage Drain Current	$V_{DS} = 16 V, V_{GS} = 0 V$			1	μA
te-Body Leakage Current, rward	$V_{GS} = 8 \ V, \ V_{DS} = 0 \ V$			100	nA
te-Body Leakage Current, verse	$V_{GS} = -8 \ V, \ V_{DS} = 0 \ V$			-100	nA
eristics (Note 2)					
te Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	0.5	0.8	1.5	V
te Threshold Voltage mperature Coefficient	$I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$		-3.5		mV/°C
tic Drain-Source -Resistance	$ \begin{array}{c} V_{GS} = 4.5 \ V, \ I_D = 7.5 \ A \\ V_{GS} = 4.5 \ V, \ I_D = 7.5 \ A, \ T_J = 125^\circ C \\ V_{GS} = 2.5 \ V, \ I_D = 6.5 \ A \end{array} $		0.013 0.021 0.016	0.018 0.034 0.022	Ω
-State Drain Current	$V_{GS}=10~V,~V_{DS}=5~V$	20			Α
rward Transconductance	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 7.5 \text{ A}$		35		S
paracteristics					
out Capacitance	$V_{DS} = 10 V, V_{GS} = 0 V,$		2130		pF
tput Capacitance	f = 1.0 MHz		545		pF
verse Transfer Capacitance	1		270		pF
haracteristics (Note 2)	_!		<b></b>		
	$V_{DD} = 10 \text{ V}, I_D = 1 \text{ A},$	<u> </u>	13	24	ns
rn-On Rise Time	$V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		26	42	ns
rn-Off Delay Time	1		65	90	ns
rn-Off Fall Time	1		23	37	ns
tal Gate Charge	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 7.5 A,		23	32	nC
te-Source Charge	$V_{GS} = 4.5 V,$		3.2		nC
te-Drain Charge	1		4.4		nC
ce Diode Characteristics	and Maximum Ratings				
				1.3	Α
ain-Source Diode Forward Itage	$V_{GS} = 0 V, I_S = 1.3 A$ (Note 2)		0.65	1.2	V
	te-Body Leakage Current, ward te-Body Leakage Current, verse eristics (Note 2) te Threshold Voltage mperature Coefficient titic Drain-Source -Resistance -State Drain Current ward Transconductance maracteristics ut Capacitance tput Capacitance tput Capacitance verse Transfer Capacitance Characteristics (Note 2) m-On Delay Time m-On Rise Time m-Off Delay Time m-Off Fall Time al Gate Charge te-Source Charge te-Drain Charge ce Diode Characteristics	te-Body Leakage Current, ward $V_{GS} = 8 V, V_{DS} = 0 V$ te-Body Leakage Current, verse $V_{GS} = -8 V, V_{DS} = 0 V$ eristics (Note 2) te Threshold Voltage $V_{DS} = V_{GS}, I_D = 250 \mu A$ Ib = 250 $\mu A$ , Referenced to 25°C mperature Coefficient $V_{GS} = 4.5 V, I_D = 7.5 A$ $V_{GS} = 4.5 V, I_D = 7.5 A, T_J = 125°C$ $V_{GS} = 2.5 V, I_D = 7.5 A, T_J = 125°C$ $V_{GS} = 2.5 V, I_D = 6.5 A$ -State Drain Current $V_{GS} = 10 V, V_{DS} = 5 V$ ward Transconductance $V_{DS} = 5 V, I_D = 7.5 A$ <b>tu</b> Capacitance $V_{DS} = 10 V, V_{GS} = 0 V, f = 1.0 MHz$ $V_{DS} = Tansfer Capacitance$ $V_{DS} = 10 V, I_D = 1 A, V_{GS} = 4.5 V, R_{GEN} = 6 \Omega$ n-On Delay Time NON Rise	te-Body Leakage Current, ward $V_{GS} = 8 V, V_{DS} = 0 V$ te-Body Leakage Current, verse $V_{GS} = -8 V, V_{DS} = 0 V$ eristics (Note 2) te Threshold Voltage $V_{DS} = V_{GS}, I_D = 250 \ \mu\text{A}$ 0.5 te Threshold Voltage $I_D = 250 \ \mu\text{A}$ , Referenced to 25°C $I_D = 250 \ \mu\text{A}$ , Referenced to 25°C $V_{GS} = 4.5 V, I_D = 7.5 \text{ A}$ -Resistance $V_{GS} = 4.5 V, I_D = 7.5 \text{ A}$ , $T_J = 125°C$ -State Drain Current $V_{GS} = 10 V, V_{DS} = 5 V$ 20 ward Transconductance $V_{DS} = 5 V, I_D = 7.5 \text{ A}$ -State Drain Current $V_{GS} = 10 V, V_{GS} = 0 V, I_D = 7.5 \text{ A}$ -The acteristics (Note 2) the Capacitance $V_{DS} = 10 V, V_{GS} = 0 V, I_D = 1.0 \text{ MHz}$ -The capacitance $V_{DS} = 10 V, I_D = 1.4, V_{GS} = 4.5 V, R_{GEN} = 6 \Omega$ -The capacitance $V_{DS} = 10 V, I_D = 1.4, V_{GS} = 4.5 V, R_{GEN} = 6 \Omega$ -The conduct of the capacitance $V_{DS} = 10 V, I_D = 1.6 \Omega, V_{GS} = 4.5 V, R_{GEN} = 6 \Omega$ -The capacitance $V_{DS} = 10 V, I_D = 7.5 A, V_{GS} = 4.5 V, R_{GEN} = 6 \Omega$	te-Body Leakage Current, ward te-Body Leakage Current, verse eristics (Note 2) te Threshold Voltage $V_{DS} = 8 \text{ V}, V_{DS} = 0 \text{ V}$ eristics (Note 2) te Threshold Voltage $V_{DS} = V_{GS}, I_D = 250 \ \mu\text{A}$ $0.5$ $0.8$ te Threshold Voltage $I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$ $-3.5$ mperature Coefficient $I_D = 250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$ $0.013$ v <sub>GS</sub> = 4.5 V, I_D = 7.5 A $T_J = 125^{\circ}\text{C}$ $0.013$ v <sub>GS</sub> = 2.5 V, I_D = 6.5 A $0.016$ -State Drain Current $V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$ 20 ward Transconductance $V_{DS} = 5 \text{ V}, I_D = 7.5 \text{ A}$ $35$ maracteristics ut Capacitance $V_{DS} = 5 \text{ V}, I_D = 7.5 \text{ A}$ $35$ maracteristics (Note 2) m-On Delay Time $T^{-1.0} \text{ MHz}$ $545$ m-Off Delay Time $T^{-1.0} \text{ MHz}$ $0.21$ m-Off Eall Time $133$ te-Source Charge $V_{DS} = 10 \text{ V}, I_D = 1 \text{ A}, V_{GS} = 4.5 \text{ V}, R_{GEN} = 6 \Omega$ $26$ m-Off Fall Time $133$ te-Source Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ V}, I_D = 7.5 \text{ A}, 3.2$ te-Drain Charge $V_{DS} = 10 \text{ C}, 1$	te-Body Leakage Current, ward te-Body Leakage Current, verse eristics (Note 2) te Threshold Voltage V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 $\mu$ A 0.5 0.8 1.5 te Threshold Voltage I <sub>D</sub> = 250 $\mu$ A, Referenced to 25°C - sperature Coefficient V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 7.5 A V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 7.5 A, T_J = 125°C 0.013 0.018 Out Capacitance V <sub>DS</sub> = 10 V, V <sub>DS</sub> = 5 V 20 ward Transconductance V <sub>DS</sub> = 5 V, I <sub>D</sub> = 7.5 A 35 to Capacitance V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz 210 Characteristics (Note 2) The On Delay Time V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 A, The On Dise Time V <sub>DS</sub> = 10 V, I <sub>D</sub> = 7.5 A, N <sub>GS</sub> = 4.5 V, R <sub>GEN</sub> = 6 Ω The On Comparison of the terms of

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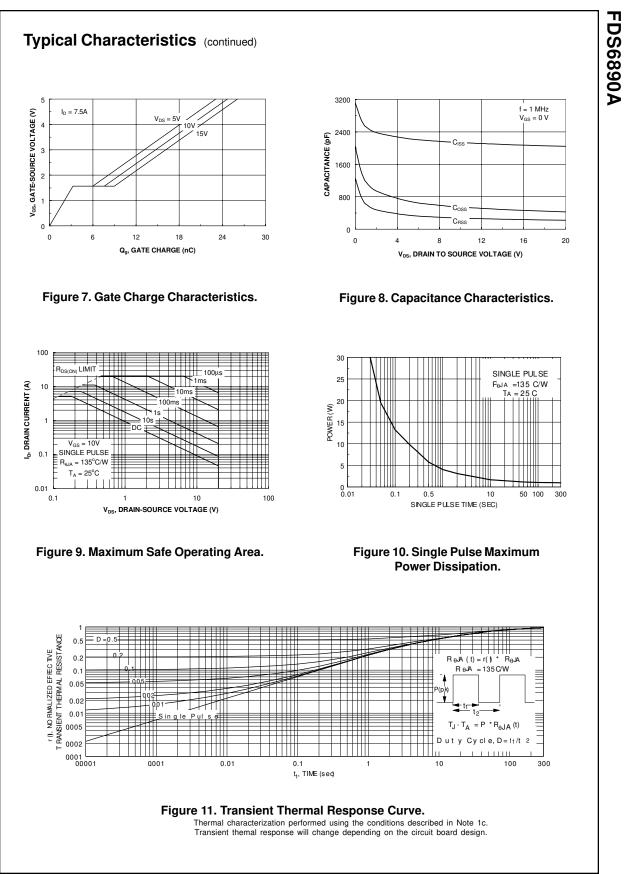
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